Electronic Components

Identification of components and handling precautions to protect them from damage due to electrostatic discharge

Passive Components Resistors Capacitors Inductors Diodes Interface components



Resistor ratings

Physical size of resistors determines power handling ability

Commonly available as 1/8, 1/4, 1/2, 1, and 2 watt components

Much higher powers available, usually as wirewound or ceramic encapsulated parts





Resistor handling and installation

Resistors are not polarized and may be installed in either direction.

Resistors are not generally susceptible to ESD damage, so special precautions are not required.

Mechanical stress due to lead bending should be minimized.





Values specified in microfarads (µF) or picofarads (pF)

Marked with actual value or a numeric code

Some varieties are +/- polarized



Capacitor types





Monolithic ceramic



Dipped siver-mica



Mylar



Mylar



Solid tantalum, polarized



Radial aluminum electrolytic



Axial aluminum electrolytic

Capacitor ratings

Physical size of capacitors is related to voltage handling ability – WVDC – working voltage DC

Temperature coefficient may also be important – can be + or – or nearly zero

Temperature coefficient depends upon dielectric material

Capacitor handling and installation

Most capacitors are not polarized and may be installed in either direction.

Electrolytic capacitors ARE polarized and MUST be installed with proper polarity, else catastrophic failure!

Capacitors are not generally susceptible to ESD damage, so special precautions are not required.

Mechanical stress due to lead bending should be minimized.



Values specified in henries (H), millihenries (mH) and microhenries (µH)

A coil of wire that may be wound on a core of air or other non-magnetic material, or on a magnetic core such as iron powder or ferrite.

Two coils magnetically coupled form a *transformer*.

Inductor types



Molded inductor & air-wound inductor



Adjustable air-wound inductor



Ferrite core toroidal transformer



Air wound inductor



Iron powder toroidal inductor

Inductor ratings

Wire gauge and physical size of the coil determine the current handling capacity.

Core material will have a temperature dependence. Air is best, followed by iron powder, then ferrites.

Inductor handling and installation

Inductors are not polarized and may be installed in either direction.

Inductors are not generally susceptible to ESD damage, so special precautions are not required.

Mechanical stress due to lead bending should be minimized.

Inductors in timing or frequency determining circuits should be installed in a mechanically rigid fashion.

Diodes

Most modern diodes are semiconductor devices, but are considered *passive* since they do not contribute any amplification or *gain* to a circuit.



Diode typesMay be classified by semiconductor materialsilicon,germanium,galliumarsenide, etc.Or classified by circuit function



Small signal detector or switching diode





Rectifier diode

Diode Ratings

Peak inverse voltage (PIV)

Maximum forward current (I_F)

Maximum forward voltage drop (V_F)

Reverse leakage current (I_R)

Diode handling and installation

Diodes are polarized and must be installed in with correct orientation.

Many diodes are modestly susceptible to ESD damage, so normal ESD precautions should be taken.

Mechanical stress due to lead bending should be minimized.

Interface components

Switches Plugs Sockets Panel controls

Two common plug styles



1/8" stereo phone plug

1/8" mono phone plug





RCA plug

Transistors Bipolar Field effect Integrated circuits Analog Digital Microcontroller

Transistors

Three terminal devices manufactured in a variety of package styles. Can you find the three terminals of this, the very first transistor?



Terminal Designations and packaging styles





2N2222 in a **TO-92** package



2SC2078 in a **TO-220** package



2N2222A in a **TO-18** package



Transistor handling and installation

Transistors are polarized and must be installed in with correct orientation.

Most BJT transistors are modestly susceptible to ESD damage, so normal ESD precautions should be taken.

MOSFET (IGFET) transistors are **very susceptible** to ESD damage, so rigorous precautions should be taken.

Mechanical stress due to lead bending should be minimized.

Integrated Circuits

Integrated circuits (ICs) are multiterminal devices that provide an array of functions and applications far to numerous to list here.



Pin identification and numbering convention

Pins are numbered sequentially in a counterclockwise direction.

Pin 1 is often identified with a dot or a dimple.

The pin 1 end of the chip is often identified with a notch.



IC handling and installation

ICs are polarized and must be installed with correct orientation. Observe pin 1 location on sockets or circuits.

Treat all ICs as if they are **very susceptible** to ESD damage (very many actually are), so rigorous precautions should be taken.

Leads generally should not be bent.

Electrostatic Discharge (ESD) Protection

Ground your work surface Use an anti-static mat Ground your tools (i.e., soldering iron) Many irons are constructed with a grounded tip Ground yourself Use a wrist or ankle strap, but always include a series resistor of high value to avoid any shock hazard. Touch a grounded object before handling static sensitive components.